ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-Ame	annockburn. Illinoi	s. All rights reserved	under both	This docume level parts, t	ent is a declaration er	on of the sub compasses	bstances w all lower	vithin the manufactu level materials for w	rer listed i which the r	tem. Note: i nanufacture	f the item is an as r has engineering	sembly with low responsibility.	
			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					ials and M	als and Mfg Information			
upplier Information													
Company name* Company unique ID			Unique ID A			D Authority			Respon	Response Date*			
nsemi	isemi								2023-06-08				
ontact Name	Title - Contact			I	Phone - Contact*				Email - Contact*				
roduct-Env-Stewards Product Enviro Compliance			e		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			itative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards	Enviro Compliance	viro Compliance		NA			Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Item Number	Mfr Item Name	Mfr Item Name		Effective Date	te Version Manufacturing Site			Weight*	UOM	Unit Type		
]	FDC6331L	331L 25/8V 55/70/100MO NC			2023-06-08		М	MY1		17.178	mg	Each	
Aanufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Ba	Terminal Base Alloy J-STD-0		Rating	Peak Proce	eak Process Body Temperat		ure Max Time at Peak Temper		ture Numb	per of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	secor	nds 3			
omments													
vel 1 - maximum time at peak temperature du	uring soldering is 1	0-30 seconds											
or more information regarding material comp	position please refe	r to page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.172	mg	Supplier	Silicon (Si)	7440-21-3		0.172	mg	
Lead Frame	8.254	mg	Supplier	Silver (Ag)	7440-22-4		0.022	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.01	mg	
			Supplier	Iron (Fe)	7439-89-6		0.198	mg	
			Supplier	Copper (Cu)	7440-50-8		8.022	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg	
Mold Compound-Black	7.596	mg		Epoxy resin	proprietary data		0.3798	mg	
			Supplier	Phenolic Resin	Proprietary Data		0.3798	mg	
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1519	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.038	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		6.6465	mg	
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg	
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg	